Specification for Approval

Customer:_____

Model Name:_____

Supplier Approval			Customer approval
R&D Designed	R&D Approved	QC Approved	
Peter	*Peng Jun*		

Revision Record

REV NO.	REV DATE	CONTENTS	Note
A	2022-03-15	NEW ISSUE	

Table of Contents

1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution.
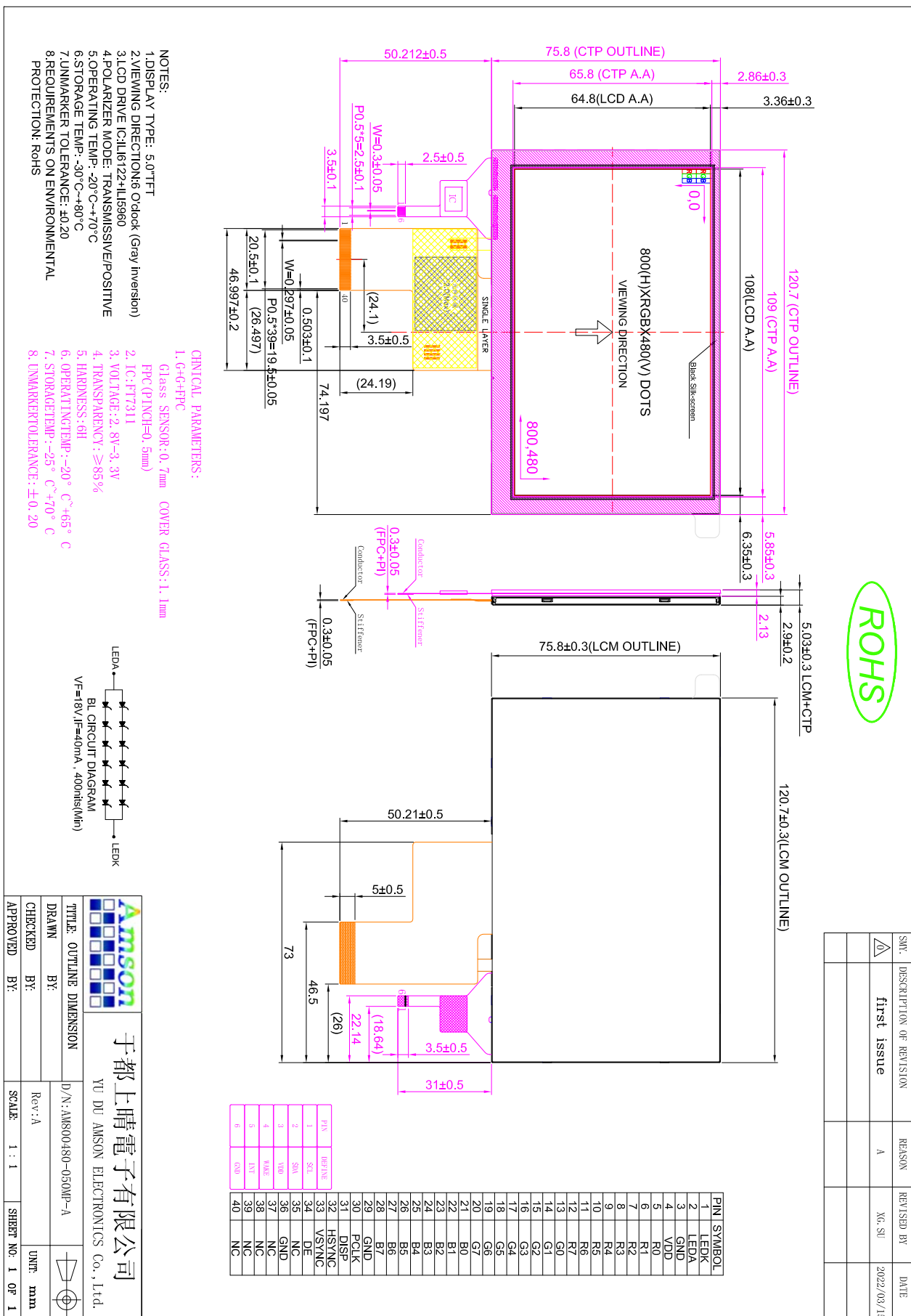
2. General Information

LCM

ITEM	STANDARD VALUES	UNITS
LCD type	5.0"TFT	--
Dot arrangement	800 (RGB)×480	dots
Color filter array	RGB vertical stripe	--
Display mode	Normally white TN	-
Gray Scale Inversion Direction	6 O'clock	--
Eyes Viewing Direction	12 O'clock	--
Driver IC	ILI6122+ILI5960	--
Module size	120.7(W)×75.8 (H)×5.03(T)	mm
Active area	108(W)×64.80(H)	mm
Dot pitch	0.135(W)×0.135(H)	mm
Interface	24-bit Parallel RGB Interface	--
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	12 White LED	--

CTP

ITEM	STANDARD VALUES	UNITS
CTP type	GLASS + Glass + FPC	--
CTP Driver IC	FT7311	--
Surface hardness	6H	--
Transmittance	≥85％	--
Operation Voltage	2.8V-3.3 V	--
CTP size	120.7(W)×75.8 (H)×1.98 (T)	mm
CTP Viewing area	109(W)×65.8(H)	mm
CTP Interface	I²C	-

3. External Dimensions

NOTES:
1.DISPLAY TYPE: 5.0"TFT
2.VIEWING DIRECTION:6 O'clock (Gray inversion)
3.LCD DRIVE IC:ILI6122+ILI5960
4.POLARIZER MODE: TRANSMISSIVE/POSITIVE
5.OPERATING TEMP: -20°C~+70°C
6.STORAGE TEMP: -30°C~+80°C
7.UNMARKER TOLERANCE: ±0.20
8.REQUIREMENTS ON ENVIRONMENTAL
PROTECTION: RoHS

CINICAL PARAMETERS:
1. G+G+FPC
Glass SENSOR: 0.7mm   COVER GLASS: 1.1mm
FPC(PINCH=0.5mm)
2. IC:FT7311
3. VOLTAGE: 2.8V~3.3V
4. TRANSPARENCY: ≥85%
5. HARDNESS: 6H
6. OPERATINGTEMP: -20°C~+65°C
7. STORAGETEMP: -25°C~+70°C
8. UNMARKERTOLERANCE: ±0.20

4. Interface Description

PIN NO.	PIN NAME	DESCRIPTION
1	LEDK	LED backlight (Cathode).
2	LEDA	LED backlight (Anode).
3	GND	Ground.
4	VDD	Power supply.
5~12	R0~R7	Red Data
13~20	G0~G7	Green Data
21~28	B0~B7	Blue Data
29	GND	Ground.
30	DCLK	Clock
31	DISP	Display on/off
32	HSYNC	Horizontal sync input in RGB mode.
33	VSYNC	Vertical sync input in RGB mode.
34	DE	Data enable input. Active high to enable the input data bus.
35	NC	No connection
36	GND	Ground.
37~40	NC	No connection.

CTP

PIN NO.	PIN NAME	
1	SCL	CTP I^{2}C_clock.
2	SDA	CTP I^{2}C_data
3	VDD	CTP Digital Power.
4	WAKE	CTP reset pin. Active low to enter reset state.
5	INT	CTP interruption signal.
6	GND	CTP Power ground

5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Logic Supply Voltage	VDD	-0.5	5.0	V
CTP Supply Voltage	VCC	2.66	3.47	V
Input Voltage	Vin	-0.3	VDD +0.3	V
Operating Temperature	T_{OP}	-20	70	°C
Storage Temperature	T_{ST}	-30	80	°C
Storage Humidity	HD	20	90	%RH

6. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Logic Supply Voltage	VDD	3.0	3.3	3.6	V	-
CTP Supply Voltage	VCC	2.8	-	3.3	V	-
Input High Voltage	V_{IH}	0.7VDD	-	VDD	V	-
Input Low Voltage	V_{IL}	GND	-	0.3 VDD	V	-
Output High Voltage	V_{OH}	VDD-0.4	-	VDD	V	-
Output Low Voltage	V_{OL}	GND	-	GND+0.4	V	-
I/O Leak Current	I_{LI}	-1	-	1	uA	-
Supply Current	IDD	-	7.0	10	mA	-

7. Timing Characteristics
7.1 Power ON/OFF Sequence

Power on sequence (VDD→VEE→VGH)
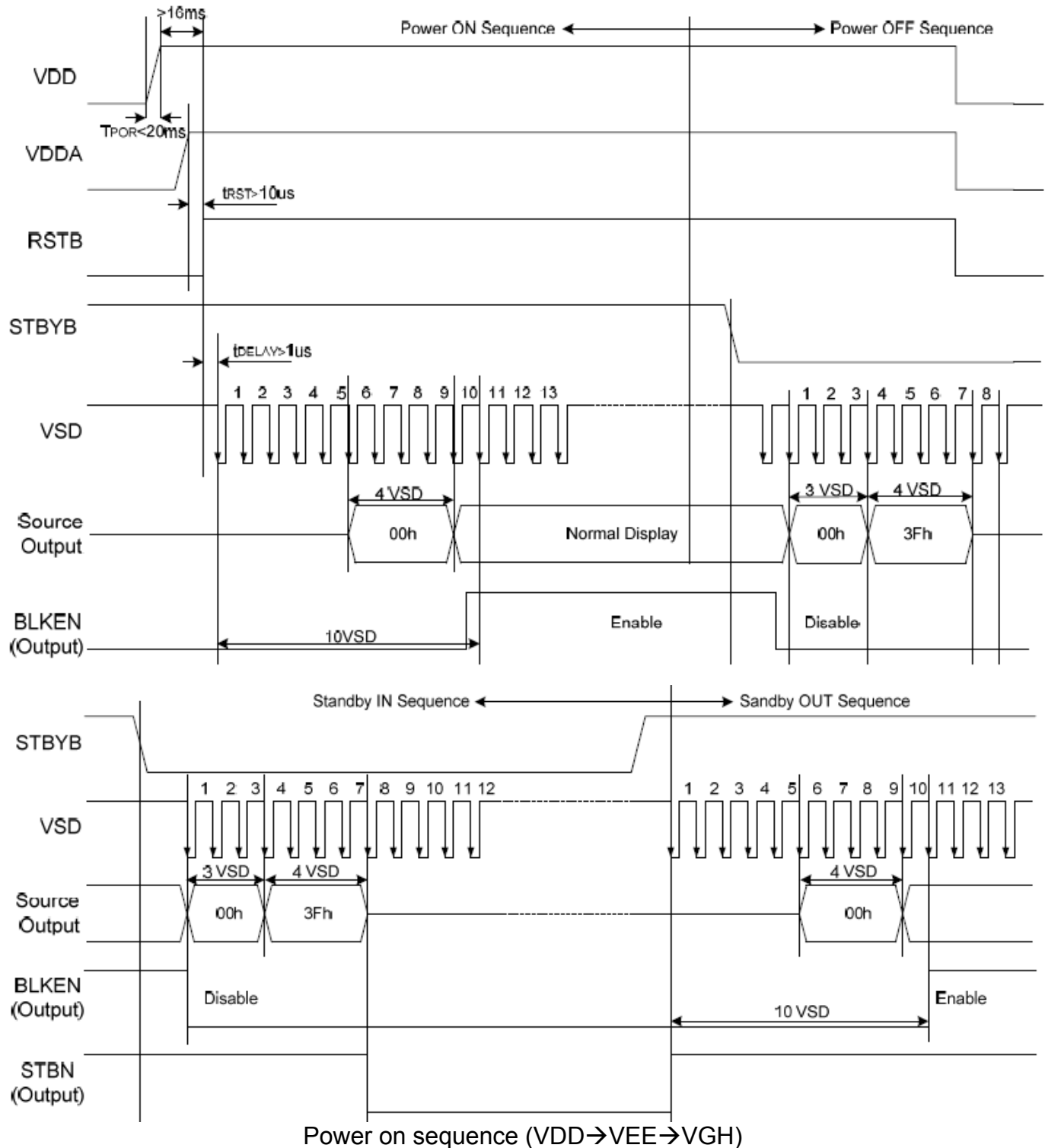
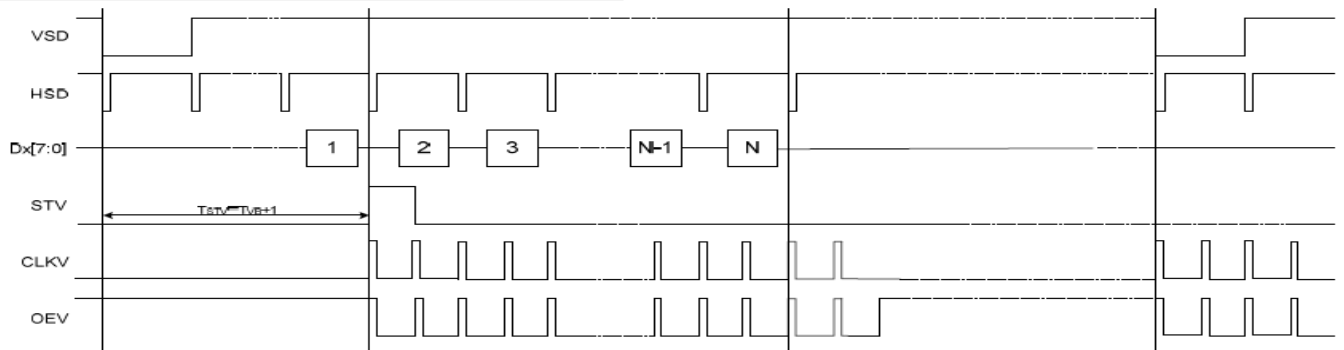## 7.2 AC Timing characteristics

DE Mode (MODE='1')
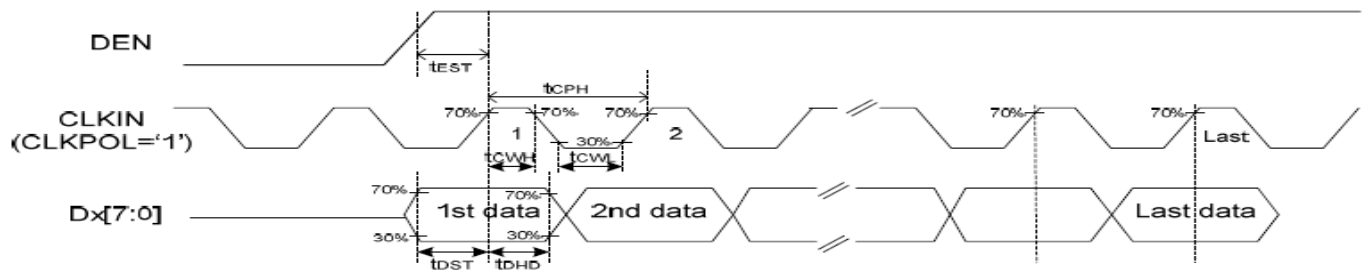
SYNC Mode (MODE='0')
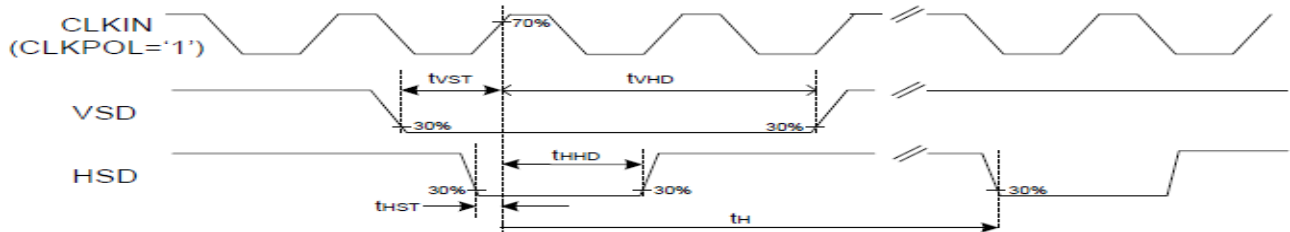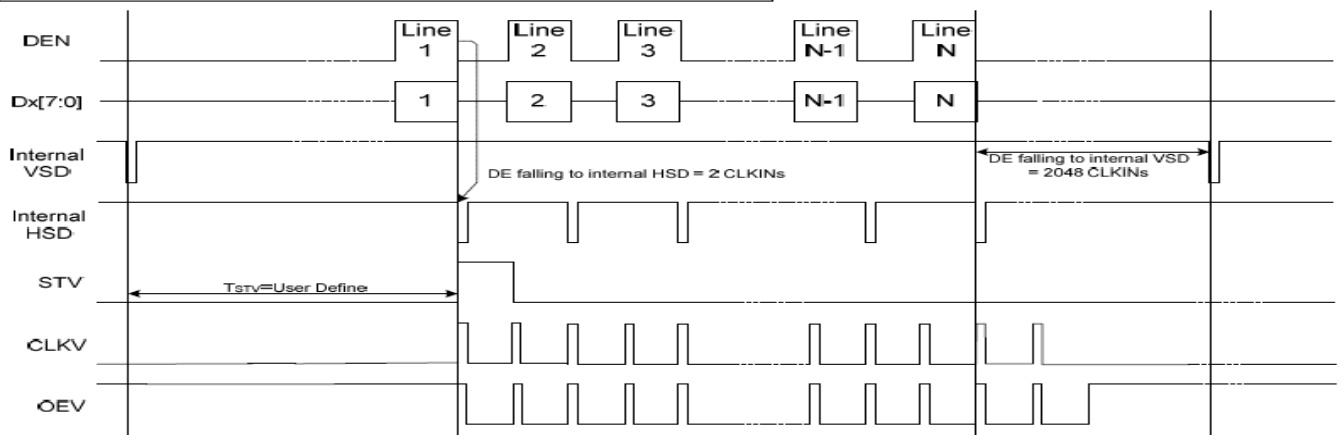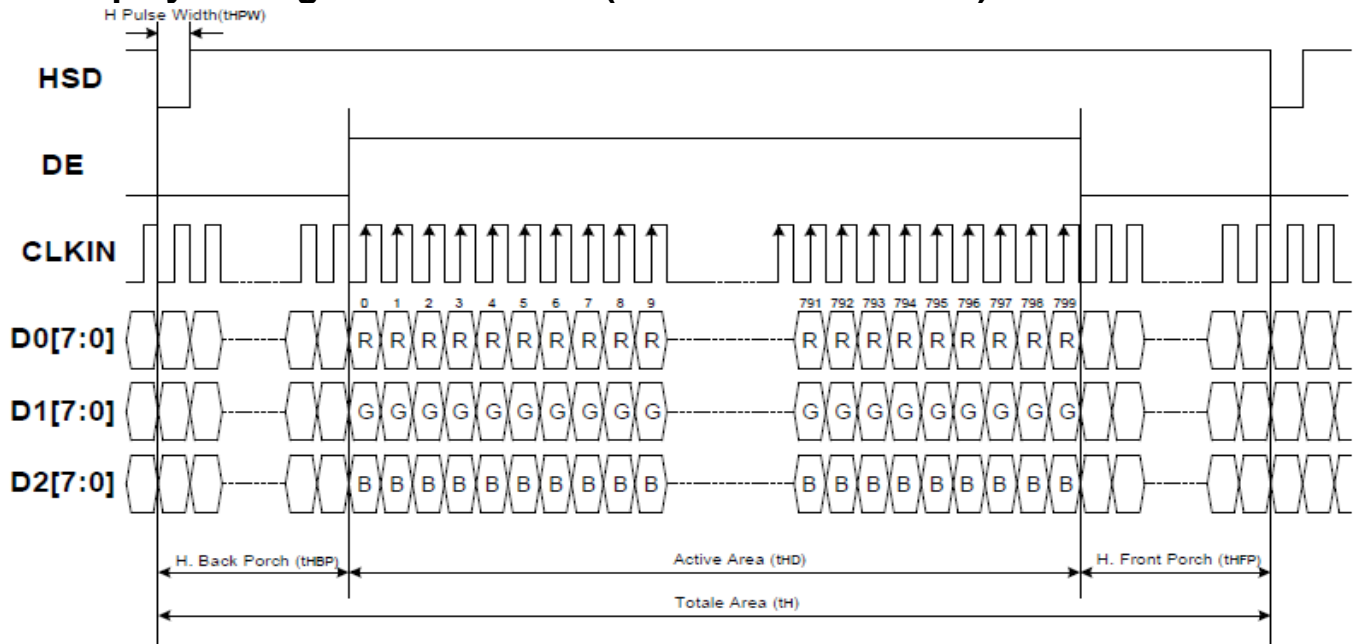

Source Output timing Diagram (Cascade)
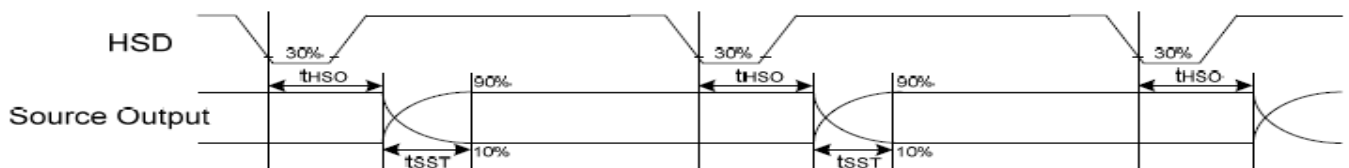
**Vertical Timing Diagram of SYNC Mode (Dual Gate)**

Vertical Timing Diagram of DE Mode (Dual Gate)

7.3 Display Timing characteristics (Resolution: 800x480)

Horizontal Input Timing

Parameter		Symbol	Value			Unit
			Min.	Typ.	Max.	
Horizontal display area		t_{HD}	--	800	--	CLKIN
CLKIN frequency		f_{CLK}	--	33.3	50	MHz
1 Horizontal line period		t_H	862	1056	1200	CLKIN
HSD pulse width	Min.	t_{HPW}	--	1	--	CLKIN
	Typ.		--	--	--	CLKIN
	Max.		--	40	--	CLKIN
HSD back porch	SYNC	t_{HBP}	46	46	46	CLKIN
HSD front porch	SYNC	t_{HFP}	16	210	354	CLKIN
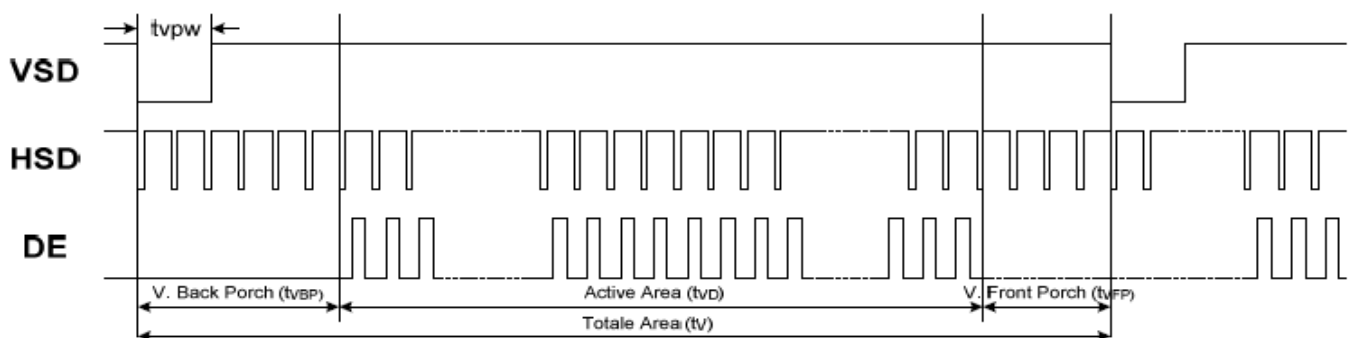
Vertical Input Timing

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Vertical display area	t_{VD}	--	480	--	HSD
VSD period time	t_V	510	525	650	HSD
VSD pulse width	t_{VPW}	1	--	20	HSD
VSD back porch	t_{VBP}	23	23	23	HSD
VSD front porch	t_{VFP}	7	22	147	HSD

7.4CTP Timing characteristics
7.4.1 Serial Interface
I^{2}C

FT7311 supports the I2C interfaces, which can be used by a host processor or other devices. The I2C is always configured in the Slave mode. The data transfer format is shown in **Figure 2-4**.
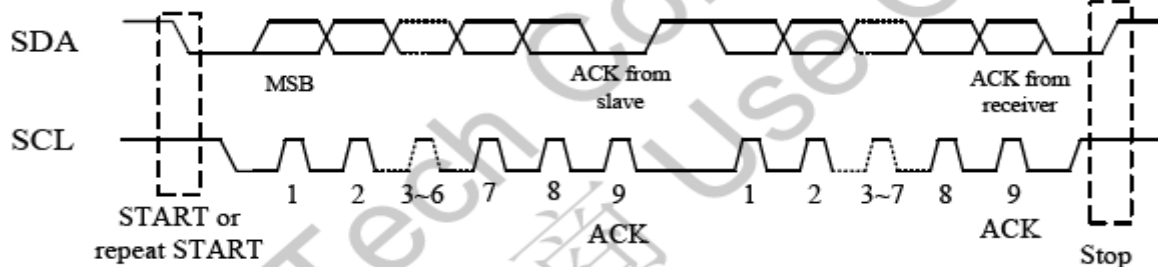

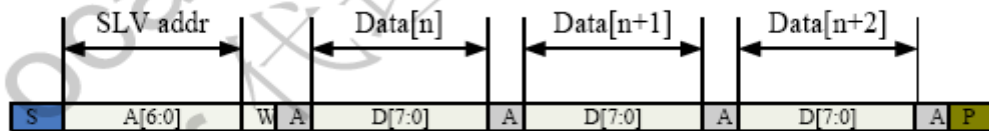Figure 2-4 I2C Serial Data Transfer Format
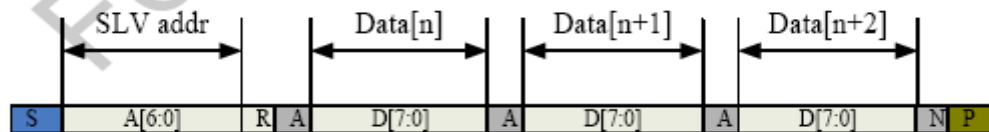

Figure 2-5 I2C master write, slave read

Figure 2-6 I2C master read, slave write

Mnemonics Description

Mnemonics	Description
S	I2C Start or I2C Restart
A[6:0]	Slave address
R/ W	READ/WRITE bit, '1' for read, '0'for write
A(N)	ACK(NACK) bit
P	STOP: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)

Timing Characteristics

Parameter	Min	Max	Unit
SCL frequency	0	400	KHz
Bus free time between a STOP and START condition	1.3		us
Hold time (repeated) START condition	0.6		us
Data setup time	100		ns
Setup time for a repeated START condition	0.6		us
Setup time for STOP condition	0.6		us
Rise time of both SDA and SCL signals	20	300	ns
Fall time of both SDA and SCL signals	20x (VDD/5.5V)	300	ns

7.4.2 POWER NO /Reset/Wake Sequence

Reset should be pulled down to be low before powering on and powering down. I2C shouldn't be used by other devices during Reset time after VDD powering on (Trtp). INT signal will be sent to the host after initializing all parameters and then start to report points to the host. If Power is down, the voltage of supply must be below 0.3V and Tpdt is more than 1ms.
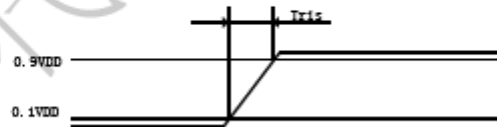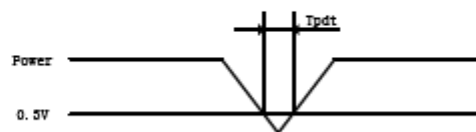
Figure 3-3 Power on time

Figure 3-4 Power Cycle requirement

Figure 3-5 Power on Sequence

Reset time must be enough to guarantee reliable reset, the time of starting to report point after resetting approach to the time of starting to report point after powering on.
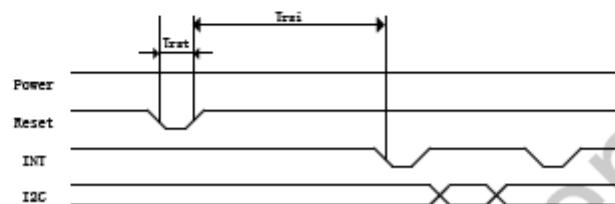
Figure 3-6 Reset Sequence

Power on/Reset Sequence Parameters

Parameter	Description	Min	Max	Units
Tris	Rise time from 0.1VDD to 0.9VDD	--	5	ms
Tpdt	Time of the voltage of supply being below 0.3V	5	--	ms
Trtp	Time of resetting to be low before powering on	100	--	μS
Tvdr	Reset time after VDD powering on	1	--	ms
Trsi	Time of starting to report point after resetting	--	200	ms
Trst	Reset time	1	--	ms

8. Backlight Characteristic
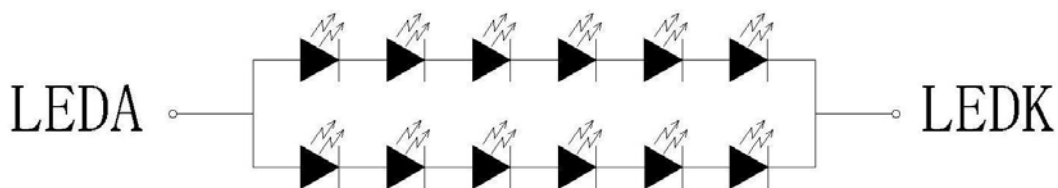
Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	16.2	18.0	19.8	V	If=40mA
Supply Current	If	-	40	-	mA	
Luminous Intensity for LCM	-	350	400	-	cd/m^2	If=40mA
Uniformity for LCM	-	80	-	-	％	If=40mA
Life Time	-	-	20000	-	Hr	If=40mA
Backlight Color	White					

9. Optical Characteristics

Item	Conditions		Min.	Typ.	Max.	Unit	Note
Viewing Angle (CR>10)	Horizontal	θL	-	70	-	degree	(1),(2),(6)
		θR	-	70	-		
	Vertical	θT	-	50	-		
		θB	-	70	-		
Contrast Ratio	Center		400	500	-	-	(1),(3),(6)
Response Time	Rising		-	10	20	ms	(1),(4),(6)
	Falling		-	15	30		
CF Color Chromaticity (CIE1931)	Red x		Typ. -0.05	TBD	Typ. +0.05	-	(1), (6)
	Red y			TBD		-	
	Green x			TBD		-	
	Green y			TBD		-	
	Blue x			TBD		-	
	Blue y			TBD		-	
	White x			TBD		-	
	White y			TBD		-	
NTSC			-	61.	-	%	(1),(6)

Note (1) Measurement Setup: The LCD module should be stabilized at given temp. 25°C for 15 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.
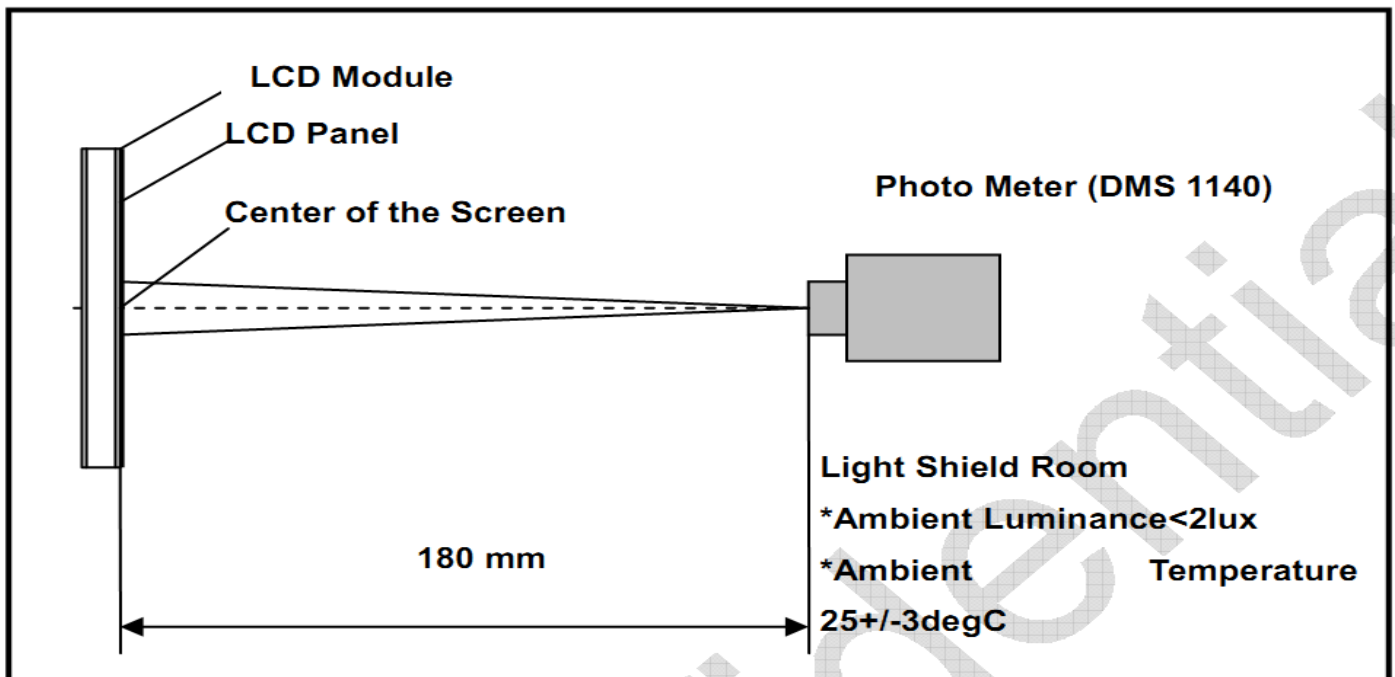
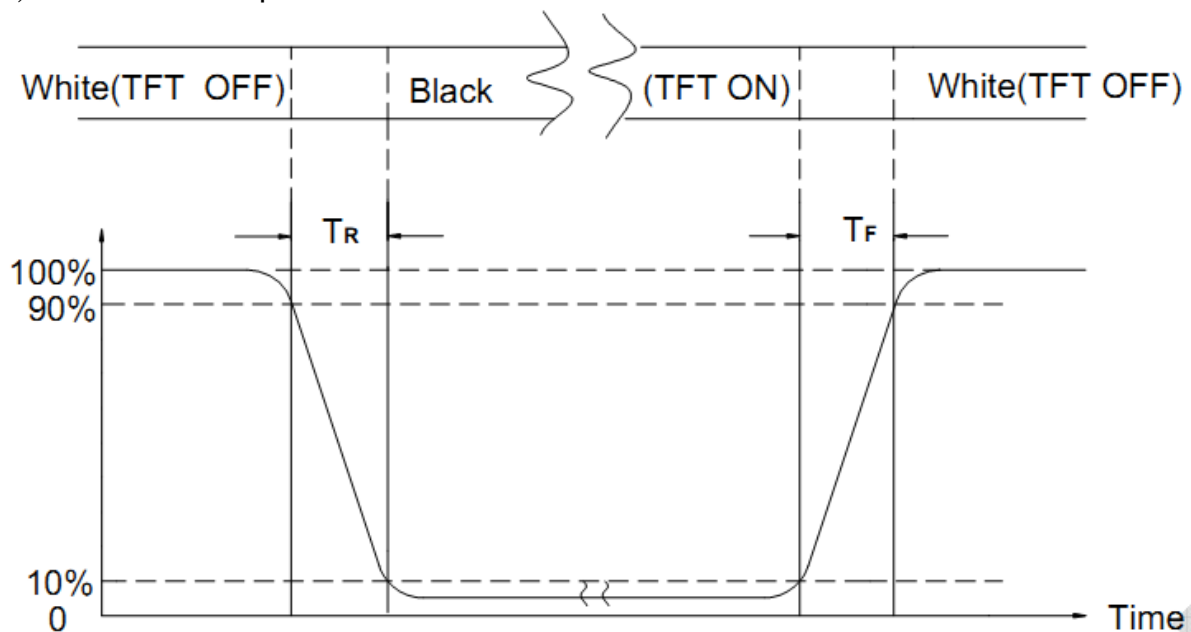Note (2) Definition of Viewing Angle
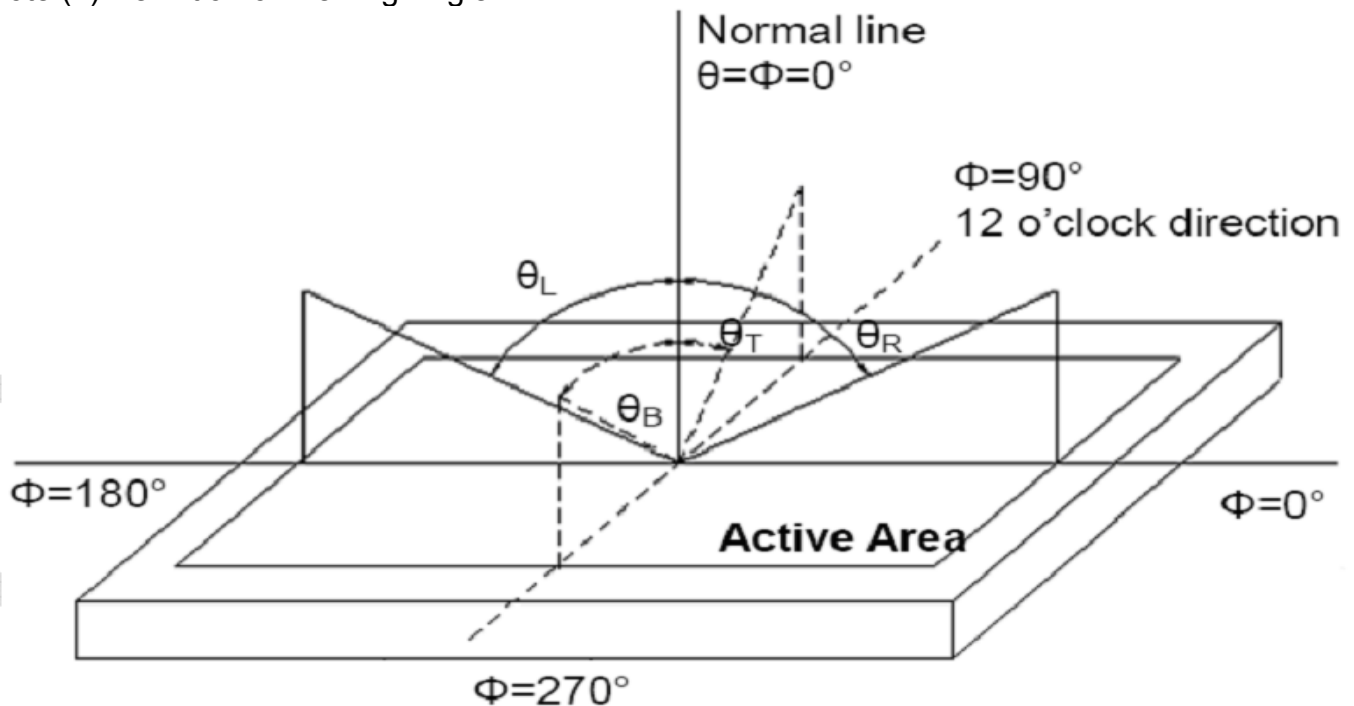
Note (3) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression

Contrast Ratio (CR) = L63 / L0

L63: Luminance of gray level 63, L0: Luminance of gray level 0

Note (4) Definition of response time

Note (5) Definition of Transmittance (Module is without signal input)

Transmittance = Center Luminance of LCD / Center Luminance of Back Light x 100%

Note (6) Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD

10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
	High Temperature Storage	80°C±2°C×96Hours	
	Low Temperature Storage	-30°C±2°C×96Hours	
	High Temperature Operating	70°C±2°C×96Hours	
	Low Temperature Operating	-20°C±2°C×96Hours	Inspection after 2~4hours storage at room temperature, the samples should be free from defects: 1, Air bubble in the LCD. 2, Seal leak. 3, Non-display. 4, Missing segments. 5, Glass crack. 6, Current IDD is twice higher than initial value. 7, The surface shall be free from damage. 8, The electric characteristic requirements shall be satisfied.
	Temperature Cycle(Storage)	-20°C ⟺ 25°C ⟺ 70°C (30min) (5min) (30min) 1cycle Total 10cycle	
	Damp Proof Test (Storage)	50°C±5°C×90%RH×96Hours	
	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5MM X,Y,Z direction for total 3hours (packing condition test will be tested by a carton)	
	Drooping Test	Drop to the ground from 1M height one time every side of carton. (packing condition test will be tested by a carton)	
	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times	

REMARK:
1, The Test samples should be applied to only one test item.
2, Sample side for each test item is 5~10pcs.
3,For Damp Proof Test, Pure water(Resistance＞10MΩ)should be used.
4,In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.
5, EL evaluation should be accepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

11. Inspection Standard

11.1. QUALITY :

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

11.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM AMSON TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10℃ TO 40℃ ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

11.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION , A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E) , LEVEL II SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %
TOTAL	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION , A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

11.1.3. WARRANTY POLICY

AMSON WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. AMSON WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF AMSON.

11.2. CHECKING CONDITION

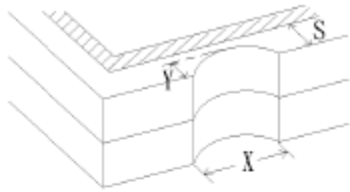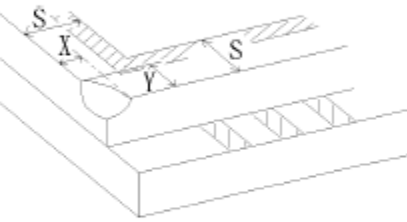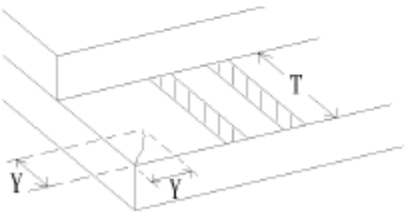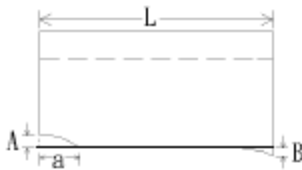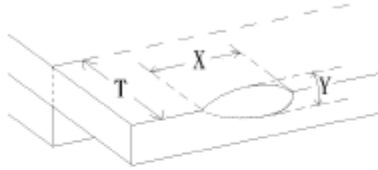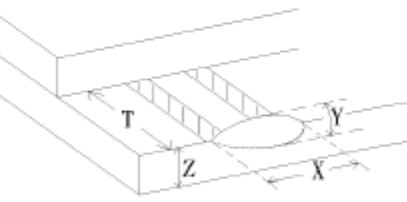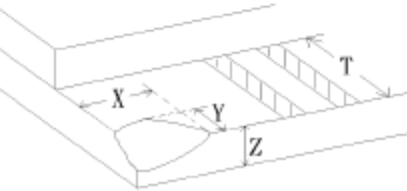11.2.1.CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.

11.2.2.CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.
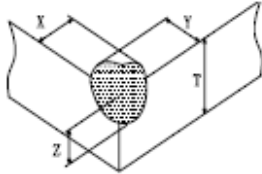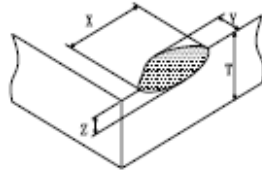
11.3. INSPECTION PLAN :

CLASS	ITEM	JUDGEMENT	CLASS
PACKING & INDICATE	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXED...............REJECTED QUANTITY SHORT OR OVER......REJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
APPEARANCE	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREA ....REJECTED	Minor
	6. BLEMISH、BLACK SPOT、WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	7. BLEMISH、BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCD......REJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
ELECTRICAL	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST、VOP、 CHROMATICITY ... ETC)	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA)	Critical
	11.MISSING LINE	MISSING DOT、LINE、CHARACTER ....REJECTED	Critical
	12.SHORT CIRCUIT、WRONG PATTERN DISPLAY	NO DISPLAY、WRONG PATTERN DISPLAY、CURRENT CONSUMPTION OUT OF SPECIFICATION...... REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL INSPECTION	Minor

11.4. STANDARD OF VISUAL INSPECTION

NO.	CLASS	ITEM	JUDGEMENT
11.4.1	MINOR	BLACK AND WHITE SPOT FOREIGN MATERIEL DUST IN THE CELL BLEMISH SCRATCH	(A) ROUND TYPE: unit : mm. (see table below) (B) LINEAR TYPE: unit : mm. (see table below)
11.4.2	MINOR	BUBBLE IN POLARIZER DENT ON POLARIZER	unit : mm. (see table below)
11.4.3	MINOR	Dot Defect	(see tables and notes below)

11.4.1 (A) ROUND TYPE: unit : mm.

DIAMETER (mm.)	ACCEPTABLE Q'TY
$\Phi \leq 0.1$	DISREGARD
$0.1 < \Phi \leq 0.25$	3 (Distance>5mm)
$0.25 < \Phi$	0

NOTE: Φ=(LENGTH+WIDTH)/2

(B) LINEAR TYPE: unit : mm.

LENGTH	WIDTH		ACCEPTABLE Q'TY
------		$W \leq 0.03$	DISREGARD
$L \leq 5.0$	$0.03 <$	$W \leq 0.07$	3 (Distance>5mm)
------	$0.07 <$	W	FOLLOW ROUND TYPE

11.4.2 unit : mm.

DIAMETER	ACCEPTABLE Q'TY
$\Phi \leq 0.2$	DISREGARD
$0.2 < \Phi \leq 0.5$	2 (Distance>5mm)
$0.5 < \Phi$	0

11.4.3 Dot Defect

Items	ACC. Q'TY
Bright dot	$N \leq 4$
Dark dot	$N \leq 4$

Pixel Define :

Note 1: The definition of dot: The size of a defective dot over 1/2 of whole dot is regarded as one defective dot.

Note 2: Bright dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.

Note 3: Dark dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green ,blue pattern.

NO.	CLASS	ITEM	JUDGEMENT
11.4.4	MINOR	LCD GLASS CHIPPING	$Y > S$ Reject
11.4.5	MINOR	LCD GLASS CHIPPING	X or $Y > S$ Reject
11.4.6	MAJOR	LCD GLASS GLASS CRACK	$Y > (1/2) T$ Reject
11.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	1. $a > L/3$, $A > 1.5mm$. Reject 2. B : ACCORDING TO DIMENSION
11.4.8	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	$\Phi = (x+y)/2 > 2.5$ mm Reject
11.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	$Y > (1/3) T$ Reject
11.4.10	MINOR	LCD GLASS CHIPPING	$Y > T$ Reject

11.5 INSPECTION STANDARD OF TOUCH PANEL

NO.	CLASS	ITEMS		JUDGEMENT	
11.5.1	MAJOR	Touch Panel Crack			Reject
11.5.2	MINOR	Touch Panel Chipping	Corner	X≦2mm, Y≦2mm, Z<1/2T	Accept
			Edge	X≦3mm, Y≦3mm, Z<1/2T	Accept
11.5.3	MINOR	Scratch Dust and Foreign materiel (Linear Type)		W≦0.05, L≦20mm	Accept
				0.05mm<W≦0.07mm; L≦10.0mm Distance between seratch>5.0mm	Accept 3 ea Max.
				W>0.07mm	Reject
11.5.4	MINOR	Scratch Dust and Foreign materiel (Round Type: Φ=(Length+Width)/2)		Φ≦0.25mm	Accept
				0.25mm<Φ≦0.35mm Distance between spots>5.0mm	Accept 5 ea Max.
				Φ>0.35mm	Reject
11.5.5	MINOR	Touch Panel Dent / Fish Eyes		Φ≦0.35mm	Accept
				0.35mm<Φ≦1.0mm Distance>5.0mm	Accept 3 ea Max.
				Φ>1.0mm	Reject
11.5.6	MINOR	Touch Panel Air Bubble		Φ≦0.2mm	Accept
				0.2mm<Φ≦0.5mm Distance between bubbles>5.0mm	Accept 3 ea Max.
				Φ>0.5mm	Reject
11.5.7	MINOR	Touch Panel Printing area Scratch		W≦0.05mm, L≦5mm Distance between scratch>5.0mm	Accept 3 ea Max.
				W>0.05mm or L>5mm (W>0.05 Follow 11.5.4 Round type)	Reject
11.5.8	MINOR	Touch Panel White Haze Mark / Dust		Can not be removed	Reject

12. Handling Precautions

12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent
[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns
Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to power or ground, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.

12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.
- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
  [It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.
- When a question is arisen in this specification.
- When a new problem is arisen this is not specified in this specification.
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT and some problem is arisen in this specification due to the change.
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method
TBD